捷多邦,专业PCB打样**SN54ABF574出SN74ABT574** OCTAL EDGE-TRIGGERED D-TYPE FLIP-FLOPS WITH 3-STATE OUTPUTS

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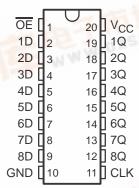
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF,
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$
- High-Drive Outputs (-32-mA I_{OH}, 64-mA IOI)
- Package Options Include Plastic Small-Outline (DW) and Shrink Small-Outline (DB) Packages, Ceramic Chip Carriers (FK), and Plastic (N) and Ceramic (J) DIPs

description

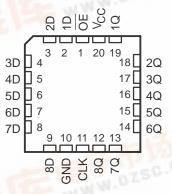
These 8-bit flip-flops feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight flip-flops of the 'ABT574 are edge-triggered D-type flip-flops. On the positive transition of the clock (CLK) input, the Q outputs are set to the logic levels that were set up at the data (D) inputs.

SN54ABT574...J PACKAGE SN74ABT574...DB, DW, OR N PACKAGE (TOP VIEW)



SN54ABT574...FK PACKAGE (TOP VIEW)



A buffered output-enable (OE) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

OE does not affect the internal operations of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, OE should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT574 is available in Tl's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54ABT574 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT574 is characterized for operation from -40°C to 85°C.

TEXAS

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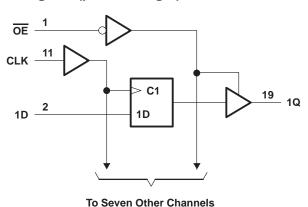
FUNCTION TABLE (each flip-flop)

	INPUTS		OUTPUT
OE	CLK	D	Q
L	1	Н	Н
L	\uparrow	L	L
L	H or L	Χ	Q ₀
Н	X	Χ	Z

logic symbol†

OE ΕN CLK > C1 2 19 1D 1D 1Q 3 18 2Q 2D 4 17 3D 3Q 5 16 4D 4Q 6 15 5D 5Q 7 14 6D 6Q 8 13 7D **7Q** 12 8D 8Q

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC} –0.5 V to 7 V
Input voltage range, V _I (see Note 1)
Voltage range applied to any output in the high state or power-off state, V_O -0.5 V to 5.5 V
Current into any output in the low state, IO: SN54ABT574
SN74ABT574 128 mA
Input clamp current, $I_{ K }(V_{ I } < 0)$
Output clamp current, I_{OK} ($V_O < 0$)
Maximum power dissipation at $T_A = 55^{\circ}C$ (in still air) (see Note 2): DB package 0.6 W
DW package 1.6 W
N package 1.3 W
Storage temperature range –65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

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recommended operating conditions (see Note 3)

			SN54A	BT574	SN74A	BT574	UNIT
			MIN	MAX	MIN	MAX	UNIT
Vcc	V _{CC} Supply voltage				4.5	5.5	V
VIH	V _{IH} High-level input voltage				2		V
V_{IL}	/IL Low-level input voltage					0.8	V
٧ _I	Input voltage		0	VCC	0	VCC	V
IOH	High-level output current			-24		-32	mA
loL	OL Low-level output current					64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		5		5	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused or floating inputs must be held high or low.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS			Т	A = 25°C	;	SN54A	BT574	SN74ABT574		UNIT	
PARAMETER				MIN	TYP [†]	MAX	MIN	MAX	MIN	MAX	ONIT	
VIK	$V_{CC} = 4.5 V$,	$I_{I} = -18 \text{ mA}$				-1.2		-1.2		-1.2	V	
	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -3 \text{ mA}$		2.5			2.5		2.5			
Vari	$V_{CC} = 5 \text{ V}, \qquad I_{OH} = -3 \text{ mA}$			3			3		3		V	
VOH	V _{CC} = 4.5 V	$I_{OH} = -24 \text{ mA}$		2			2				V	
	VCC = 4.5 V	$I_{OH} = -32 \text{ mA}$		2*					2			
Val	V00 - 4 5 V	I _{OL} = 48 mA				0.55		0.55			V	
VOL	V _{CC} = 4.5 V	I _{OL} = 64 mA				0.55*				0.55	V	
lį	$V_{CC} = 5.5 V$,	V _I = V _{CC} or GND				±1		±1		±1	μΑ	
lozh	$V_{CC} = 5.5 V$,	V _O = 2.7 V				50		10		50	μΑ	
lozL	$V_{CC} = 5.5 V$,	V _O = 0.5 V				-50		-10		-50	μΑ	
l _{off}	$V_{CC} = 0$,	V_I or $V_O \le 4.5 \text{ V}$				±100		±500		±100	μΑ	
ICEX	$V_{CC} = 5.5 V$,	V _O = 5.5 V	Outputs high			50		50		50	μΑ	
lo [‡]	$V_{CC} = 5.5 V$,	$V_0 = 2.5 \text{ V}$		-50	-100	-180	-50	-180	-50	-180	mA	
	$V_{CC} = 5.5 \text{ V}, I_{O} = 0,$ $V_{I} = V_{CC} \text{ or GND}$		Outputs high		1	250		250		250	μΑ	
lcc			Outputs low		24	30		30		30	mA	
	Outputs		Outputs disabled		0.5	250		250		250	μΑ	
ΔICC§	V_{CC} = 5.5 V, One input at 3.4 V, Other inputs at V_{CC} or GND					1.5		1.5		1.5	mA	
Ci	V _I = 2.5 V or 0.5 V				3						pF	
Co	$V_0 = 2.5 \text{ V or } 0$	0.5 V			8						pF	

^{*} On products compliant to MIL-STD-883, Class B, this parameter does not apply.



[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[§] This is the increase in supply current for each input that is at the specified TTL voltage level rather than VCC or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

			V _{CC} = 5 V, T _A = 25°C		SN54ABT574		SN74ABT574		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
fclock	ock Clock frequency			150		150		150	MHz
t _W	Pulse duration, CLK high or low		3.3		3.3		3.3		ns
	Catura times data hafara CLKA	High	1		1.5		1		no
t _{su}	Setup time, data before CLK↑	Low	1.5		2		1.5		ns
t _h	Hold time, data after CLK↑	High or low	1.5†		2		1.5†		ns

[†]This data sheet limit may vary among suppliers.

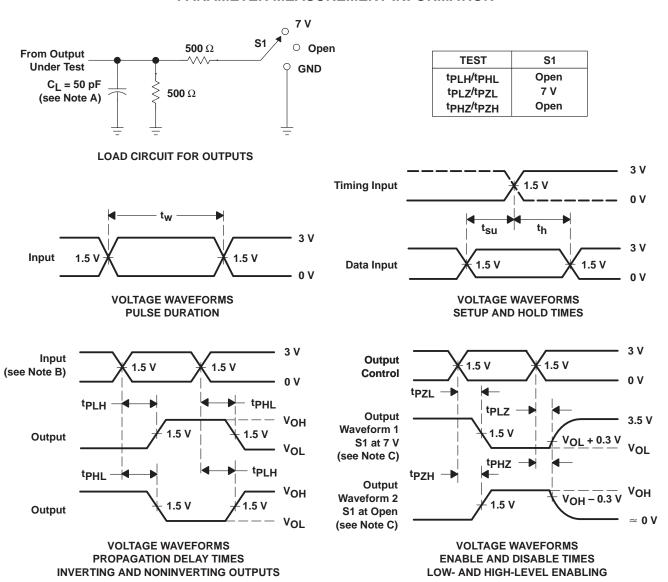
switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTBUT)		I IΛ = 25°C		SN54ABT574		SN74ABT574		UNIT
	(INFOT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
fmax			150	200		150		150		MHz
t _{PLH}	CLK	Q	2.2	3.9	6.2	2.2	7	2.2	6.8	ns
^t PHL		σ	3	4.8	6.6	3	7.4	3	7.1	115
^t PZH	ŌĒ	Q	1	3.3	4.3	1	5.8	1	5.1	ns
t _{PZL}	OE .	3	2.5	4.7	5.9	2.5	7.2	2.5	6.7	115
^t PHZ	ŌĒ	Q	2.4	4.9	6.2	2.4	7.2	2.4	7	ns
tPLZ	OE .	3	2	4	5.8	2	6.7	2	6.5	115

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_Q = 50 \ \Omega$, $t_f \leq 2.5 \ ns$, $t_f \leq 2.5 \ ns$.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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